

1200V, 85A,  $V_{ce(on)}$  = 2.5V Typical

# Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT® offers superior ruggedness and ultrafast switching speed.

#### **Features**

- · Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- · Short Circuit Withstand Rated
- · High Frequency Switching
- Ultra Low Leakage Current





-55 to 150

300

°C

All Ratings: T<sub>C</sub> = 25°C unless otherwise specified.

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

## **MAXIMUM RATINGS**

 $\mathsf{T}_{\mathsf{J}}, \mathsf{T}_{\mathsf{STG}}$ 

T,

Symbol	Parameter	Ratings	Unit
V <sub>ces</sub>	Collector Emitter Voltage	1200	V
$V_{GE}$	Gate-Emitter Voltage	±30	V
I <sub>C1</sub>	Continuous Collector Current @ T <sub>C</sub> = 25°C	118	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>c</sub> = 75°C	85	Α
I <sub>CM</sub>	Pulsed Collector Current ①	340	
SCWT	Short Circuit Withstand Time: V <sub>CE</sub> = 600V, V <sub>GE</sub> = 15V, T <sub>C</sub> =125°C	10	μs
P <sub>n</sub>	Total Power Dissipation @ T <sub>c</sub> = 25°C	595	W

#### STATIC ELECTRICAL CHARACTERISTICS

Operating and Storage Junction Temperature Range

Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage $(V_{GE} = 0V, I_{C} = 1.0 \text{mA})$	1200			
V <sub>GE(TH)</sub>	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	Volts
V <sub>CE(ON)</sub>	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{C}$ = 85A, $T_{j}$ = 25°C)		2.5	3.2	
	Collector-Emitter On Voltage ( $V_{GE} = 15V$ , $I_{C} = 85A$ , $T_{j} = 125^{\circ}C$ )		3.3		
	Collector-Emitter On Voltage ( $V_{GE} = 15V$ , $I_{C} = 170A$ , $T_{j} = 25^{\circ}C$ )		3.5		
I <sub>CES</sub>	Collector Cut-off Current (V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) ②		10	1000	μA
	Collector Cut-off Current (V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C) ②		100		
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)	ĺ		±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

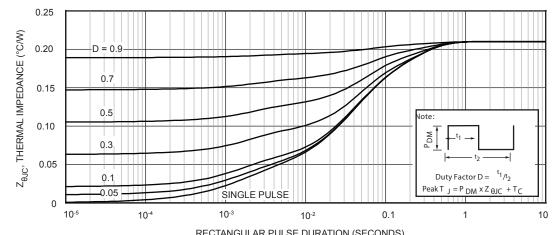
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		8400		
C <sub>oes</sub>	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		725		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		190		
$V_{GEP}$	Gate to Emitter Plateau Voltage	Cata Charra		7.5		V
Q3	Total Gate Charge	Gate Charge		490	660	
$Q_{ge}$	Gate-Emitter Charge	V <sub>GE</sub> = 15V		60	85	0
$Q_{gc}$	Gate- Collector Charge	$V_{CE} = 600V$ $I_{C} = 85A$		230	320	nC
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)		43		
t <sub>r</sub>	Current Rise Time	V <sub>CC</sub> = 600V		70		20
$t_{d(off)}$	Turn-Off Delay Time	V <sub>GE</sub> = 15V		300		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 85A		85		
E <sub>on2</sub> ⑤	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3  \Omega^{(4)}$		6000	9000	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +25°C		3800	5700	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)		43		
t <sub>r</sub>	Current Rise Time	V <sub>CC</sub> = 600V		70		20
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		350		ns
t <sub>f</sub>	Current Fall Time	I <sub>C</sub> = 85A		95		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3 \ \Omega^{\textcircled{4}}$		7800	11,700	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +125°C		4900	7350	μJ

### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	Min	Тур	Max	Unit
$R_{_{\theta JC}}$	Junction to Case	-	-	0.21	°C/W
W <sub>T</sub>	Package Weight	-	1.03	-	OZ
Torque	Terminals and Mounting Screws.	-	-	10	in∙lbf
		-	-	1.1	N·m
V	RMS Voltage (50-60Hz Sinusoidal Waveform from Terminals to Mounting Base for 1 Min.)	2500	-	-	Volts

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width <  $380\mu s$ , duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4  $\,$  R $_{\rm G}$  is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5  $E_{\text{on2}}$  is the energy loss at turn-on and includes the charge stored in the freewheeling diode.
- 6 E<sub>off</sub> is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (SECONDS)
Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

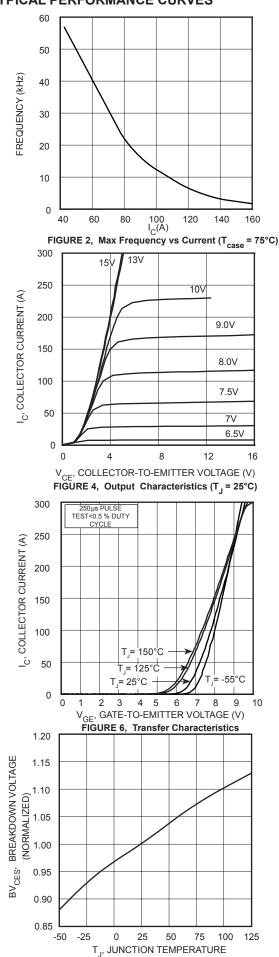


FIGURE 8, Breakdown Voltage vs Junction Temperature

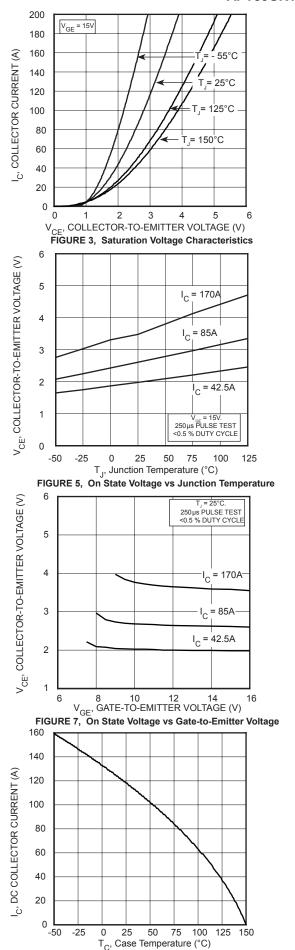


FIGURE 9, DC Collector Current vs Case Temperature

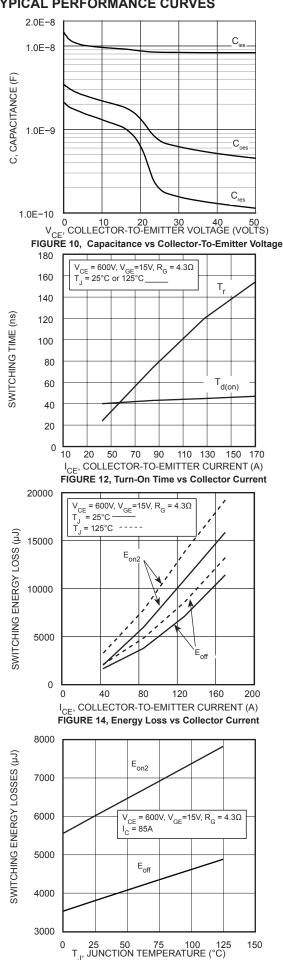
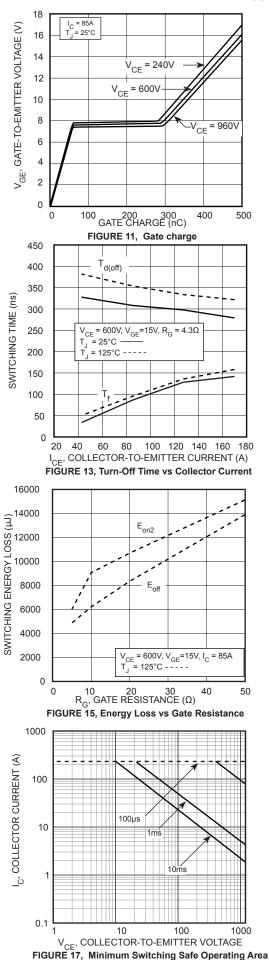
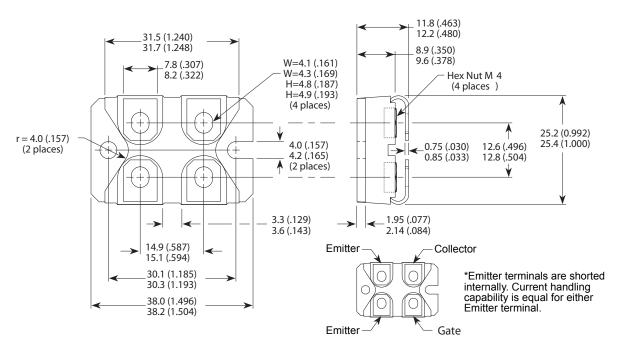


FIGURE 16, Switching Energy vs Junction Temperature



## SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp